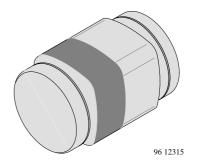
Silicon Epitaxial Planar Diodes

Features

- Saving space
- Hermetic sealed parts
- Fits onto SOD 323 / SOT 23 footprints
- Electrical data identical with the devices BAV100...BAV103 / BAV200...BAV203



Applications

General purposes

Absolute Maximum Ratings

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Peak reverse voltage		BAV300	V_{RRM}	60	V
		BAV301	V_{RRM}	120	V
		BAV302	V_{RRM}	200	٧
		BAV303	V_{RRM}	250	V
Reverse voltage		BAV300	V_{R}	50	٧
		BAV301	V_{R}	100	٧
		BAV302	V_R	150	٧
		BAV303	V_R	200	٧
Forward current			I _F	250	mΑ
Peak forward surge current	t _p =1s, T _i =25°C		I _{FSM}	1	Α
Forward peak current	f=50Hz		I _{FM}	625	mΑ
Junction temperature			Tį	175	Ĵ
Storage temperature range			T _{stg}	<i>−</i> 65+175	°C

Maximum Thermal Resistance

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	mounted on epoxy-glass hard tissue, Fig. 1	R_{thJA}	500	K/W
	35μm copper clad, 0.9 mm ² copper area per electrode			

BAV300...BAV303

Vishay Telefunken



Electrical Characteristics

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Type	Symbol	Min	Тур	Max	Unit
Forward voltage	I _F =100mA		V_{F}			1	V
Reverse current	V _R =50V	BAV300	I _R			100	nA
	V _R =100V	BAV301	I _R			100	nA
	V _R =150V	BAV302	I _R			100	nA
	V _R =200V	BAV303	I _R			100	nA
	T _j =100°C, V _R = 50V	BAV300	I _R			15	μΑ
	T _i =100°C, V _R = 100V	BAV301	I _R			15	μΑ
	T _j =100°C, V _R = 150V	BAV302	I _R			15	μΑ
	T _i =100°C, V _R = 200V	BAV303	I _R			15	μΑ
Breakdown voltage	$I_R=100\mu A, t_p/T=0.01,$	BAV300	V _(BR)	60			V
	t _p =0.3ms	BAV301	V _(BR)	120			V
		BAV302	V _(BR)	200			V
		BAV303	V _(BR)	250			V
Diode capacitance	V _R =0, f=1MHz		CD		1.5		pF
Differential forward resistance	I _F =10mA		r _f		5		Ω
Reverse recovery time	$I_F=I_R=30$ mA, $I_R=3$ mA, $I_L=100\Omega$		t _{rr}			50	ns

Characteristics $(T_j = 25^{\circ}C \text{ unless otherwise specified})$

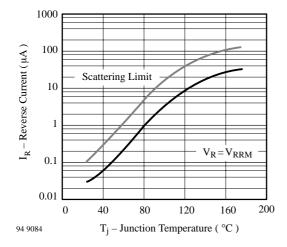


Figure 1. Reverse Current vs. Junction Temperature

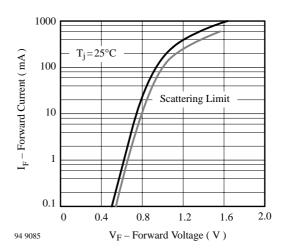


Figure 2. Forward Current vs. Forward Voltage



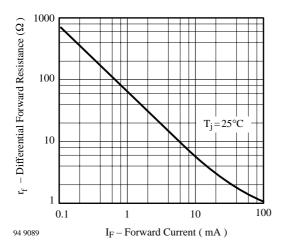


Figure 3. Differential Forward Resistance vs. Forward Current

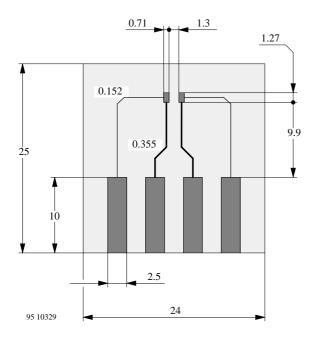


Figure 4. Board for R_{thJA} definition (in mm)

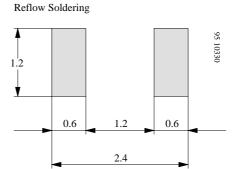


Figure 5. Recommended foot pads (in mm)

Wave Soldering

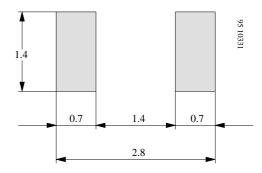
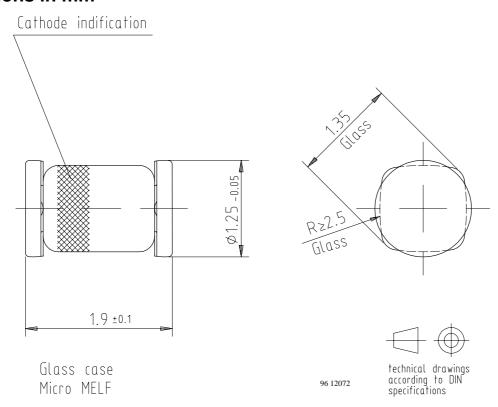


Figure 6. Recommended foot pads (in mm)

VISHAY

Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems

with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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